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PNP resistor-equipped transistor; $R1 = 47 \text{ k}\Omega$, $R2 = 22 \text{ k}\Omega$ Rev. 1 — 2 July 2012 Product data s

Product data sheet

1. **Product profile**

1.1 General description

PNP Resistor-Equipped Transistor (RET) in a leadless ultra small DFN1006B-3 (SOT883B) Surface-Mounted Device (SMD) plastic package.

NPN complement: PDTC144WMB.

1.2 Features and benefits

- 100 mA output current capability
- Reduces component count
- Built-in bias resistors
- Reduces pick and place costs

1.3 Applications

Quick reference date

Table 4

- Low-current peripheral driver
- Control of IC inputs

- Simplifies circuit design
- AEC-Q101 qualified
- Leadless ultra small SMD plastic package
- Low package height of 0.37 mm
- Replaces general-purpose transistors in digital applications
- Mobile applications

1.4 Quick reference data

| Table 1. | Quick reference data | | | | | |
|-----------|---------------------------|--------------------------|------|------|------|------|
| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
| V_{CEO} | collector-emitter voltage | open base | - | - | -50 | V |
| lo | output current | | - | - | -100 | mA |
| R1 | bias resistor 1 (input) | T _{amb} = 25 °C | 33 | 47 | 61 | kΩ |
| R2/R1 | bias resistor ratio | | 0.37 | 0.47 | 0.57 | |



PNP resistor-equipped transistor; R1 = 47 k Ω , R2 = 22 k Ω

2. Pinning information

| Table 2. | Pinning | information | | |
|----------|---------|--------------------|---|----------------------|
| Pin | Symbol | Description | Simplified outline | Graphic symbol |
| 1 | I | input (base) | | |
| 2 | G | GND (emitter) | | 3 |
| 3 | 0 | output (collector) | 2 Transparent top view DFN1006B-3 (SOT883B) | 1 R2 R2 sym003 |

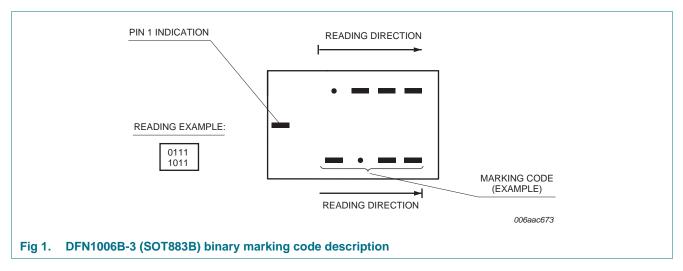
3. Ordering information

| Table 3. Ordering information | | | | | |
|-------------------------------|------------|---|---------|--|--|
| Type number | Package | | | | |
| | Name | Description | Version | | |
| PDTA144WMB | DFN1006B-3 | Leadless ultra small plastic package; 3 solder lands; body 1.0 x 0.6 x 0.37 mm | SOT883B | | |

4. Marking

| Table 4. | Marking | codes |
|----------|---------|-------|
|----------|---------|-------|

| Type number | Marking code |
|-------------|--------------|
| PDTA144WMB | 0010 1110 |



PNP resistor-equipped transistor; R1 = 47 k Ω , R2 = 22 k Ω

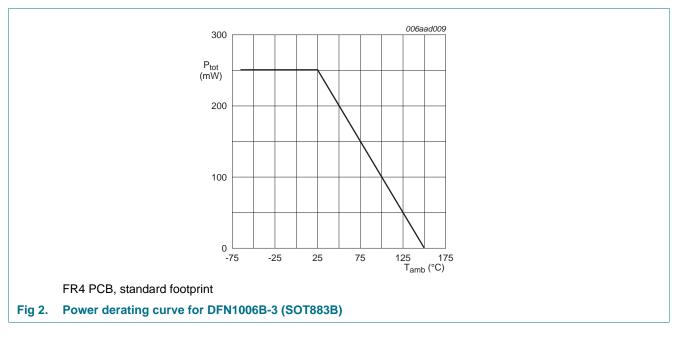
5. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

| Symbol | Parameter | Conditions | | Min | Max | Unit |
|------------------|---------------------------|-------------------------------|------------|-----|------|------|
| V _{CBO} | collector-base voltage | open emitter | | - | -50 | V |
| V _{CEO} | collector-emitter voltage | open base | | - | -50 | V |
| V _{EBO} | emitter-base voltage | open collector | | - | -10 | V |
| VI | input voltage | positive | | - | 10 | V |
| | | negative | | - | -40 | V |
| lo | output current | | | - | -100 | mA |
| I _{CM} | peak collector current | pulsed; t _p ≤ 1 ms | | - | -100 | mA |
| P _{tot} | total power dissipation | T _{amb} ≤ 25 °C | <u>[1]</u> | - | 250 | mW |
| Tj | junction temperature | | | - | 150 | °C |
| T _{amb} | ambient temperature | | | -65 | 150 | °C |
| T _{stg} | storage temperature | | | -65 | 150 | °C |

[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.



6. Thermal characteristics

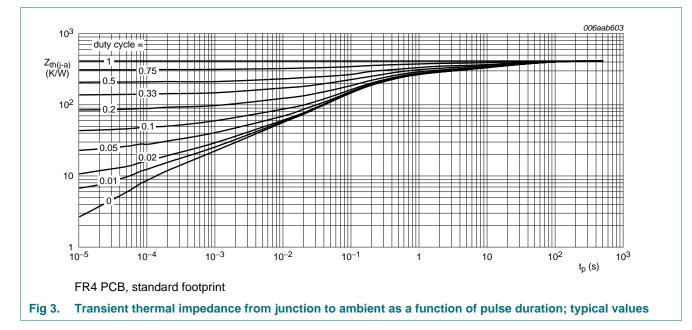
| Table 6. | Thermal characteristics | | | | | | |
|----------------------|---|-------------|------------|-----|-----|-----|------|
| Symbol | Parameter | Conditions | | Min | Тур | Max | Unit |
| R _{th(j-a)} | thermal resistance from junction to ambient | in free air | <u>[1]</u> | - | - | 500 | K/W |

[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

| PDTA144WMB | |
|--------------------|--|
| Product data sheet | |

PDTA144WMB

PNP resistor-equipped transistor; R1 = 47 k Ω , R2 = 22 k Ω



7. Characteristics

Table 7. Characteristics

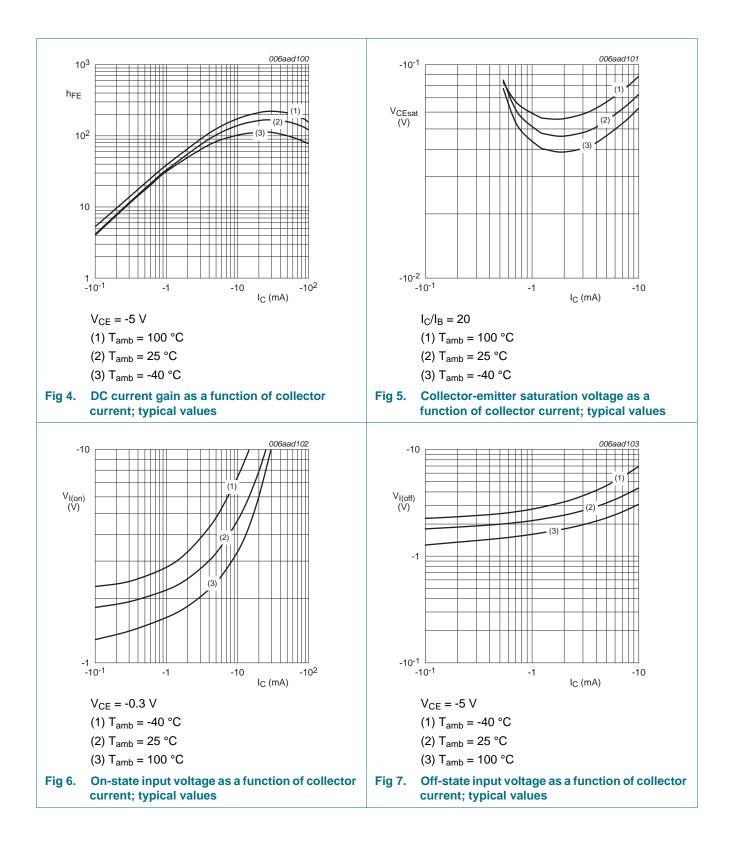
| Table 7. | Characteristics | | | | | | |
|---------------------|--------------------------------------|---|------------|------|------|------|------|
| Symbol | Parameter | Conditions | | Min | Тур | Max | Unit |
| I _{CBO} | collector-base cut-off current | V_{CB} = -50 V; I _E = 0 A; T _{amb} = 25 °C | | - | - | -100 | nA |
| I _{CEO} | collector-emitter cut-off | V_{CE} = -30 V; I _B = 0 A; T _{amb} = 25 °C | | - | - | -1 | μΑ |
| | current | V_{CE} = -30 V; I _B = 0 A; T _j = 150 °C | | - | - | -5 | μΑ |
| I _{EBO} | emitter-base cut-off current | V_{EB} = -5 V; I _C = 0 A; T _{amb} = 25 °C | | - | - | -110 | μΑ |
| h _{FE} | DC current gain | V_{CE} = -5 V; I _C = -5 mA; T _{amb} = 25 °C | | 60 | - | - | |
| V _{CEsat} | collector-emitter saturation voltage | I_{C} = -10 mA; I_{B} = -0.5 mA; T_{amb} = 25 °C | | - | - | -150 | mV |
| V _{I(off)} | off-state input voltage | V_{CE} = -5 V; I_C = -100 $\mu A;$ T_{amb} = 25 $^\circ C$ | | - | -1.7 | -1.2 | V |
| V _{I(on)} | on-state input voltage | V_{CE} = -0.3 V; I _C = -2 mA; T _{amb} = 25 °C | | -4 | -2.7 | - | V |
| R1 | bias resistor 1 (input) | T _{amb} = 25 °C | | 33 | 47 | 61 | kΩ |
| R2/R1 | bias resistor ratio | | | 0.37 | 0.47 | 0.57 | |
| C _C | collector capacitance | V _{CB} = -10 V; I _E = 0 A; i _e = 0 A; f = 1 MHz; T _{amb} = 25 °C | | - | - | 3 | pF |
| f _T | transition frequency | V_{CE} = -5 V; I _C = -10 mA; f = 100 MHz; T _{amb} = 25 °C | <u>[1]</u> | - | 180 | - | MHz |
| | | | | | | | |

[1] Characteristics of built-in transistor.

PDTA144WMB Product data sheet

PDTA144WMB

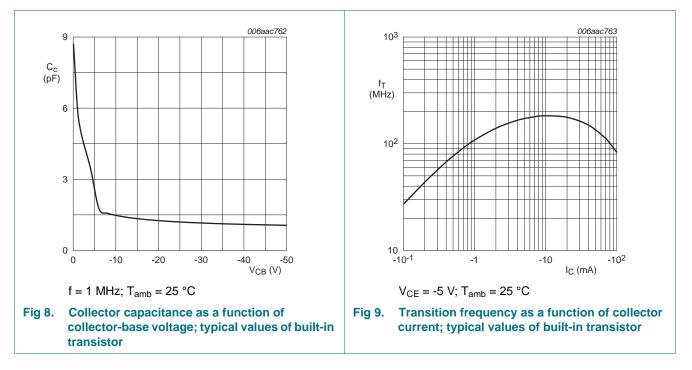
PNP resistor-equipped transistor; R1 = 47 k Ω , R2 = 22 k Ω



PDTA144WMB Product data sheet

NXP Semiconductors

PNP resistor-equipped transistor; R1 = 47 k Ω , R2 = 22 k Ω



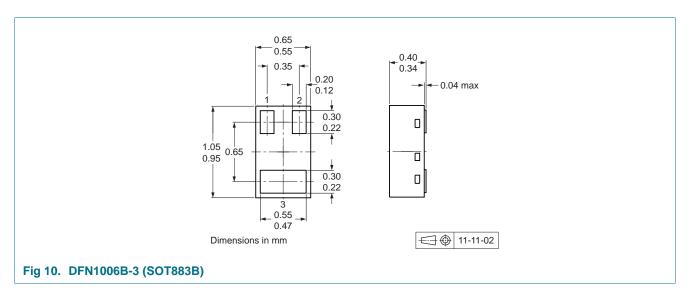
8. Test information

8.1 Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard Q101 - Stress test qualification for discrete semiconductors, and is suitable for use in automotive applications.

PNP resistor-equipped transistor; R1 = 47 k Ω , R2 = 22 k Ω

Package outline 9.



10. Soldering

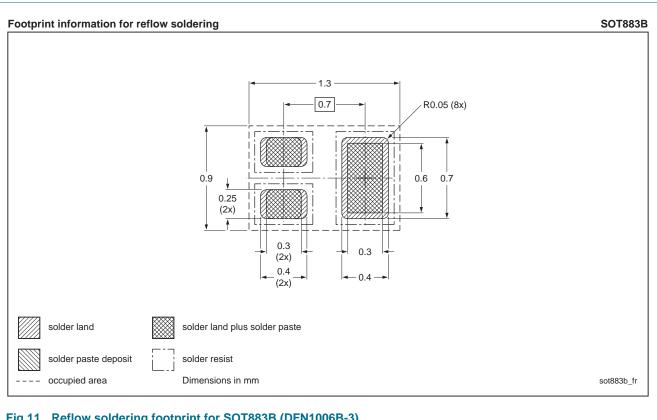


Fig 11. Reflow soldering footprint for SOT883B (DFN1006B-3)

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PNP resistor-equipped transistor; R1 = 47 k Ω , R2 = 22 k Ω

11. Revision history

| Table 8. Revision h | istory | | | |
|---------------------|--------------|--------------------|---------------|------------|
| Document ID | Release date | Data sheet status | Change notice | Supersedes |
| PDTA144WMB v.1 | 20120702 | Product data sheet | - | - |

PNP resistor-equipped transistor; $R1 = 47 \text{ k}\Omega$, $R2 = 22 \text{ k}\Omega$

12. Legal information

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| Document status[1] [2] | Product status ^[3] | Definition |
|--------------------------------|-------------------------------|---|
| Objective [short] data sheet | Development | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet | Qualification | This document contains data from the preliminary specification. |
| Product [short] data sheet | Production | This document contains the product specification. |

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Product data sheet

PDTA144WMB

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